

## DEVICE SPECIFICATIONS

# NI 5752/5752B

## 50 MS/s Digitizer Adapter Module

This document lists specifications for the NI 5752/5752B adapter module. Pair these specifications with the specifications listed in your FlexRIO FPGA specifications document or your controller for FlexRIO specifications document.

*Maximum* and *minimum* specifications are warranted not to exceed these values within certain operating conditions and include the effects of temperature and uncertainty unless otherwise noted.

*Characteristic* specifications are unwarranted values that are representative of an average unit operating at room temperature

*Typical* specifications are unwarranted values that are representative of a majority (90%) of units within certain operating conditions and include the effects of temperature and uncertainty unless otherwise noted.



**Note** Using the NI 5752/5752B in a manner not described in this document may impair the protection that the NI 5752/5752B provides.



**Caution** To avoid permanent damage to the NI 5752/5752B, disconnect all signals connected to the NI 5752/5752B before powering down the module, and only connect signals after the module has been powered on by the FlexRIO FPGA module or the controller for FlexRIO.



**Note** These specifications are characteristic at 25 °C unless otherwise noted.

Specifications are subject to change without notice. For the most recent device specifications, visit [ni.com/manuals](http://ni.com/manuals).

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# FlexRIO Documentation

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**Table 1.** FlexRIO Documentation Locations and Descriptions

<b>Document</b>	<b>Location</b>	<b>Description</b>
Getting started guide for your FlexRIO FPGA module or controller for FlexRIO	Available from the Start menu and at <a href="http://ni.com/manuals">ni.com/manuals</a> .	Contains installation instructions for your FlexRIO system.
Specifications document for your FlexRIO FPGA module or controller for FlexRIO	Available from the Start menu and at <a href="http://ni.com/manuals">ni.com/manuals</a> .	Contains specifications for your FlexRIO FPGA module or controller for FlexRIO.
Getting started guide for your adapter module	Available from the Start menu and at <a href="http://ni.com/manuals">ni.com/manuals</a> .	Contains signal information, examples, and CLIP details for your adapter module.
Specifications document for your adapter module	Available from the Start menu and at <a href="http://ni.com/manuals">ni.com/manuals</a> .	Contains specifications for your adapter module.
<i>LabVIEW FPGA Module Help</i>	Embedded in <i>LabVIEW Help</i> and at <a href="http://ni.com/manuals">ni.com/manuals</a> .	Contains information about the basic functionality of the LabVIEW FPGA Module.

**Table 1. FlexRIO Documentation Locations and Descriptions (Continued)**

Document	Location	Description
<i>Real-Time Module Help</i>	Embedded in <i>LabVIEW Help</i> and at <a href="http://ni.com/manuals">ni.com/manuals</a> .	Contains information about real-time programming concepts, step-by-step instructions for using LabVIEW with the Real-Time Module, reference information about Real-Time Module VIs and functions, and information about LabVIEW features on real-time operating systems.
<i>FlexRIO Help</i>	Available from the Start menu and at <a href="http://ni.com/manuals">ni.com/manuals</a> .	Contains information about the FPGA module front panel connectors and I/O, controller for FlexRIO front panel connectors and I/O, programming instructions, and adapter module component-level IP (CLIP).
<i>FlexRIO Adapter Module Development Kit User Manual</i>	Available from the Start menu at <b>Start»All Programs»National Instruments»NI FlexRIO»NI FlexRIO Adapter Module Development Kit»Documentation</b> .	Contains information about how to create custom adapter modules for use with FlexRIO FPGA modules.
LabVIEW Examples	Available in NI Example Finder. In LabVIEW, click <b>Help»Find Examples»Hardware Input and Output»FlexRIO</b> .	Contains examples of how to run FPGA VIs and Host VIs on your device.
IPNet	Located at <a href="http://ni.com/ipnet">ni.com/ipnet</a> .	Contains LabVIEW FPGA functions and intellectual property to share.
FlexRIO product page	Located at <a href="http://ni.com/flexrio">ni.com/flexrio</a> .	Contains product information and data sheets for FlexRIO devices.

# Absolute Maximum Ratings

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**Caution** Stresses beyond those listed in this section may cause permanent damage to the adapter module. Avoid swapping the analog and digital cables because doing so will short the digital output terminals to ground.

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(AI+, AI-)	$\pm 2.1$ V
External clock input	-0.5 V to 3.5 V
Digital input	-0.5 V to 3.5 V
Digital output current	2 mA

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## Analog Input (AI 0 to AI 31)

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### General Characteristics

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Type of connector	2 VHDCI (dual stack)
Number of channels	32, differential, simultaneously sampled (single-ended can be achieved by setting the VGA gain to 6 dB)
Max input voltage swing	
Differential	$2 V_{pk-pk}$
Single-ended	$1 V_{pk-pk}$
Gain range	-5 dB to 31 dB
Gain resolution	0.125 dB
Common mode range	$\pm 1$ VDC
Input impedance	100 $\Omega$ (AI+, AI-)
Coupling	AC-coupled
ADC manufacturer part number	AFE5801 monolithic analog front end, including a variable gain amplifier and a 12-bit differential pipelined A/D converter

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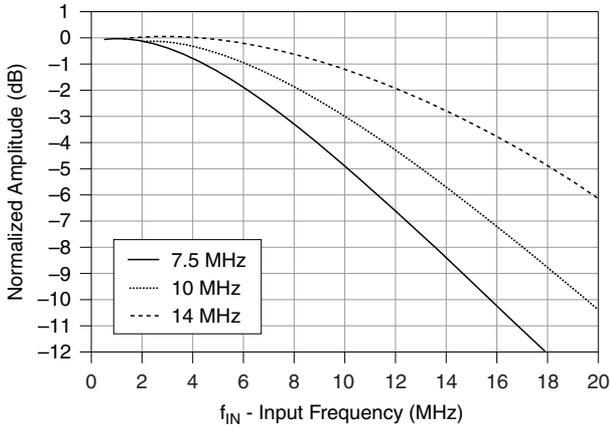
### Specific Characteristics

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Anti-aliasing filter (-3 dB)	7.5 MHz, 10 MHz, and 14 MHz
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**Figure 1. Anti-aliasing Filter Frequency Response -0 dB Reference at 800 kHz Amplitude**



Gain error

-5 dB to 28 dB	±1.2 dB
>28 dB	±1.8 dB
AC coupling cutoff	16 kHz <sup>1</sup>
Crosstalk	<-75 dB at 1 MHz <sup>2</sup>
Signal-to-noise ratio (SNR)	66 dBc <sup>3</sup>
Spurious-free dynamic range (SFDR)	65 dBc <sup>4</sup>
Total harmonic distortion (THD)	64 dBc <sup>5</sup>
Average noise density	7.4 nV/√Hz <sup>6</sup>

<sup>1</sup> 100 Ω source assumed, AFE5801 internal VGA DC coupling enabled

<sup>2</sup> Measured on one channel with the test signal applied to another channel, with the same range setting on both channels

<sup>3</sup> -1 dBFS differential input signal, 6 dB gain,  $f_{in} = 2$  MHz

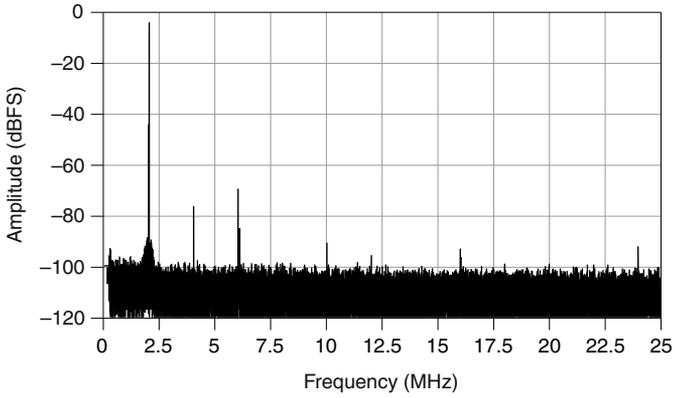
<sup>4</sup> -1 dBFS differential input signal, 17 dB gain,  $f_{in} = 2$  MHz

<sup>5</sup> -1 dBFS differential input signal, 17 dB gain,  $f_{in} = 2$  MHz

<sup>6</sup> Input referenced, 5 MHz, 31 dB gain, low-noise mode

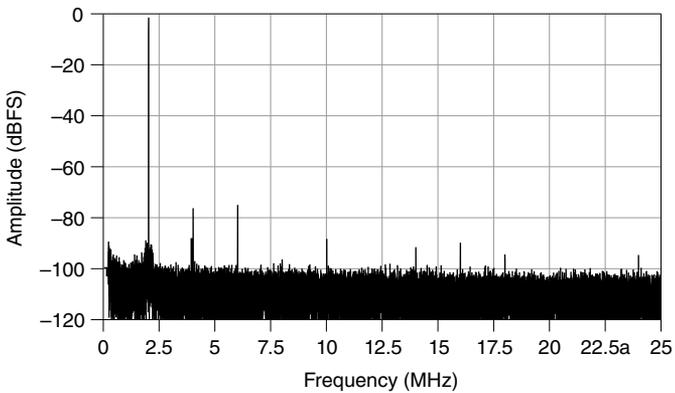
**Figure 2.** Characteristic Dynamic Performance, Spectrum-64,000 Samples, Coarse Gain 6 dB, 2 MHz, -1 dBFS Differential-Ended Input Signal

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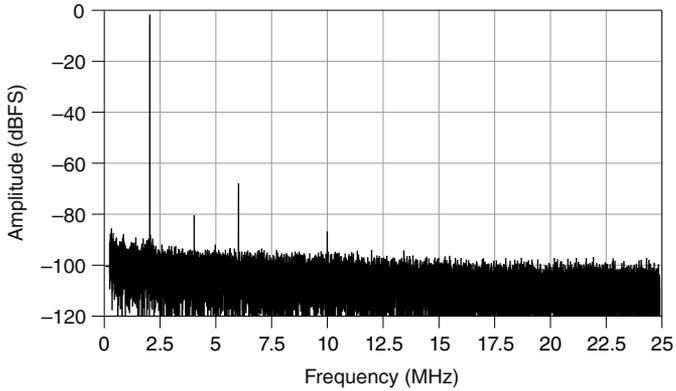
**Figure 3.** Characteristic Dynamic Performance, Spectrum-64,000 Samples, Coarse Gain 12 dB, 2 MHz, -1 dBFS Differential-Ended Input Signal

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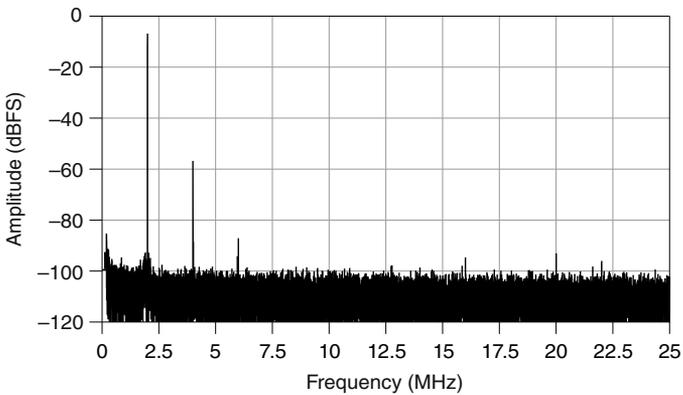
**Figure 4.** Characteristic Dynamic Performance, Spectrum-64,000 Samples, Coarse Gain 30 dB, 2 MHz, -1 dBFS Differential-Ended Input Signal

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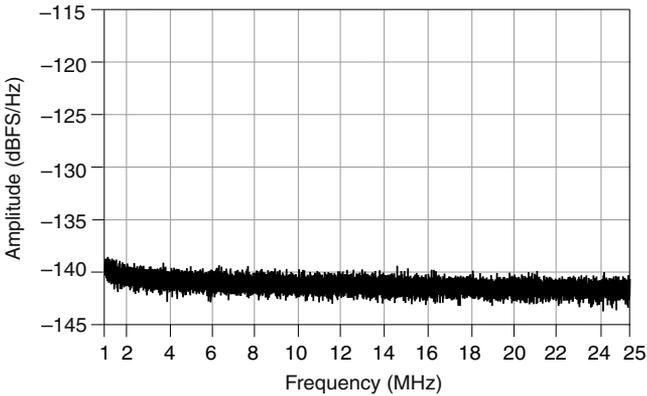


**Figure 5.** Characteristic Dynamic Performance, Spectrum-64,000 Samples, Coarse Gain 6 dB, 2 MHz, -6 dBFS Single-Ended Input Signal

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**Figure 6.** Characteristic Noise Density, Spectrum-64,000 Samples, Coarse Gain 0 dB



### Related Information

*For more information on the AFE5801, refer to the device data sheet at [ti.com](http://ti.com).*

## Sample Clock

Sample Clock sources	50 MHz onboard clock, Sync Clock (PXIe_DSTARA) <sup>7,8</sup> , or CLK IN <sup>9</sup> (front panel SMB)
Sample Clock frequency range	25 MHz to 50 MHz <sup>10</sup>

## CLK IN

Connector	SMB
Logic level	3.3 V CMOS
Minimum high-level input voltage (V <sub>IH</sub> )	2.2 V

<sup>7</sup> Sync Clock (PXIe\_DSTARA) is only available on NI PXI Express FlexRIO FPGA modules, such as the NI PXIe-796xR. On PXI Express modules, Sync Clock is driven by the PXIe\_DSTARA signal from the PXI/PXI Express backplane. For NI PXI modules, such as the NI PXI-795xR, and controllers for FlexRIO, such as the NI-793xR, Sync Clock (PXIe\_DSTARA) is not available.

<sup>8</sup> If you change the frequency of Sync Clock (PXIe\_DSTARA) or CLK IN (when used as the Sample Clock), you must assert ForceInit.

<sup>9</sup> If you change the frequency of Sync Clock (PXIe\_DSTARA) or CLK IN (when used as the Sample Clock), you must assert ForceInit.

<sup>10</sup> If you change the frequency of Sync Clock (PXIe\_DSTARA) or CLK IN (when used as the Sample Clock), you must assert ForceInit.

Maximum low-level input voltage ( $V_{IL}$ )	0.6 V
Input impedance	> 50 k $\Omega$
Input coupling	DC
Duty cycle	45% to 55%

## Digital Inputs

Number of channels	2
Connector	VHDCI
Minimum high-level input voltage ( $V_{IH}$ (min))	2.0 V
Maximum low-level input voltage ( $V_{IL}$ (max))	0.8 V

## Digital Outputs

Number of channels	16
Connector	VHDCI
Minimum high-level output voltage ( $V_{OH}$ (min))	2.4 V
Maximum low-level output voltage ( $V_{OL}$ (max))	0.55 V
Maximum output current	1 mA
Minimum pulse width	10 ns
Maximum toggle frequency	1 MHz, all outputs toggling



**Caution** Avoid swapping the analog and digital cables because doing so will short the digital output terminals to ground and cause harmful currents to flow out from the module.

## Power

Power requirements from the FPGA device	
+12 V	200 mA, 2.4 W max
+3.3 V	878 mA, 2.9 W max
Total power	5.3 W

## Physical

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Dimensions	12.9 × 2.0 × 12.1 cm (5.1 × 0.8 × 4.7 in.)
Weight	284 g (10 oz)
Front panel connectors	One SMB connector and three 68-pin VHDCI connectors

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## Environment

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Maximum altitude	2,000 m (800 mbar) (at 25 °C ambient temperature)
Pollution Degree	2

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Indoor use only.

## Operating Environment

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Ambient temperature range	0 °C to 55 °C (Tested in accordance with IEC 60068-2-1 and IEC 60068-2-2. Meets MIL-PRF-28800F Class 3 low temperature limit and MIL-PRF-28800F Class 2 high temperature limit.)
Relative humidity range	10% to 90%, noncondensing (Tested in accordance with IEC 60068-2-56.)

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## Storage Environment

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Ambient temperature range	-20 °C to 71 °C (Tested in accordance with IEC 60068-2-1 and IEC 60068-2-2. Meets MIL-PRF-28800F Class 3 limits.)
Relative humidity range	5% to 95%, noncondensing (Tested in accordance with IEC 60068-2-56.)

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## Shock and Vibration

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Operating shock	30 g peak, half-sine, 11 ms pulse (Tested in accordance with IEC 60068-2-27. Meets MIL-PRF-28800F Class 2 limits.)
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## Random vibration

Operating	5 Hz to 500 Hz, 0.3 g <sub>rms</sub>
Nonoperating	5 Hz to 500 Hz, 2.4 g <sub>rms</sub> (Tested in accordance with IEC 60068-2-64. Nonoperating test profile exceeds the requirements of MIL-PRF-28800F, Class 3.)

# Compliance and Certifications

## Safety

This product is designed to meet the requirements of the following electrical equipment safety standards for measurement, control, and laboratory use:

- IEC 61010-1, EN 61010-1
- UL 61010-1, CSA 61010-1



**Note** For UL and other safety certifications, refer to the product label or the [Online Product Certification](#) section.

## Electromagnetic Compatibility

This product meets the requirements of the following EMC standards for electrical equipment for measurement, control, and laboratory use:

- EN 61326-1 (IEC 61326-1): Class A emissions; Basic immunity
- EN 55011 (CISPR 11): Group 1, Class A emissions
- EN 55022 (CISPR 22): Class A emissions
- EN 55024 (CISPR 24): Immunity
- AS/NZS CISPR 11: Group 1, Class A emissions
- AS/NZS CISPR 22: Class A emissions
- FCC 47 CFR Part 15B: Class A emissions
- ICES-001: Class A emissions



**Note** In the United States (per FCC 47 CFR), Class A equipment is intended for use in commercial, light-industrial, and heavy-industrial locations. In Europe, Canada, Australia, and New Zealand (per CISPR 11), Class A equipment is intended for use only in heavy-industrial locations.



**Note** Group 1 equipment (per CISPR 11) is any industrial, scientific, or medical equipment that does not intentionally generate radio frequency energy for the treatment of material or inspection/analysis purposes.



**Note** For EMC declarations, certifications, and additional information, refer to the [Online Product Certification](#) section.

# CE Compliance

This product meets the essential requirements of applicable European Directives, as follows:

- 2014/35/EU; Low-Voltage Directive (safety)
- 2014/30/EU; Electromagnetic Compatibility Directive (EMC)

## Online Product Certification

Refer to the product Declaration of Conformity (DoC) for additional regulatory compliance information. To obtain product certifications and the DoC for this product, visit [ni.com/certification](http://ni.com/certification), search by model number or product line, and click the appropriate link in the Certification column.

## Environmental Management

NI is committed to designing and manufacturing products in an environmentally responsible manner. NI recognizes that eliminating certain hazardous substances from our products is beneficial to the environment and to NI customers.

For additional environmental information, refer to the *Minimize Our Environmental Impact* web page at [ni.com/environment](http://ni.com/environment). This page contains the environmental regulations and directives with which NI complies, as well as other environmental information not included in this document.

## Waste Electrical and Electronic Equipment (WEEE)



**EU Customers** At the end of the product life cycle, all NI products must be disposed of according to local laws and regulations. For more information about how to recycle NI products in your region, visit [ni.com/environment/weee](http://ni.com/environment/weee).

## 电子信息产品污染控制管理办法（中国 RoHS）



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